AN8017SA

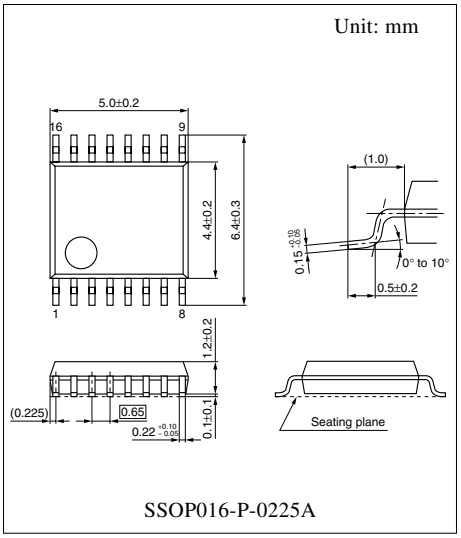
1.8-volt 2-channel step-up DC-DC converter control IC

■ Overview

The AN8017SA is a two-channel PWM DC-DC converter control IC that features low-voltage operation.

This IC can obtain the step-up voltage with a small number of external components.

The minimum operating voltage is as low as 1.8 V so that it can operate with two dry batteries. In addition, since it uses the 16-pin surface mounting type package with 0.65 mm pitch, it is suitable for a miniaturized highly efficient potable power supply.



SSOP016-P-0225A

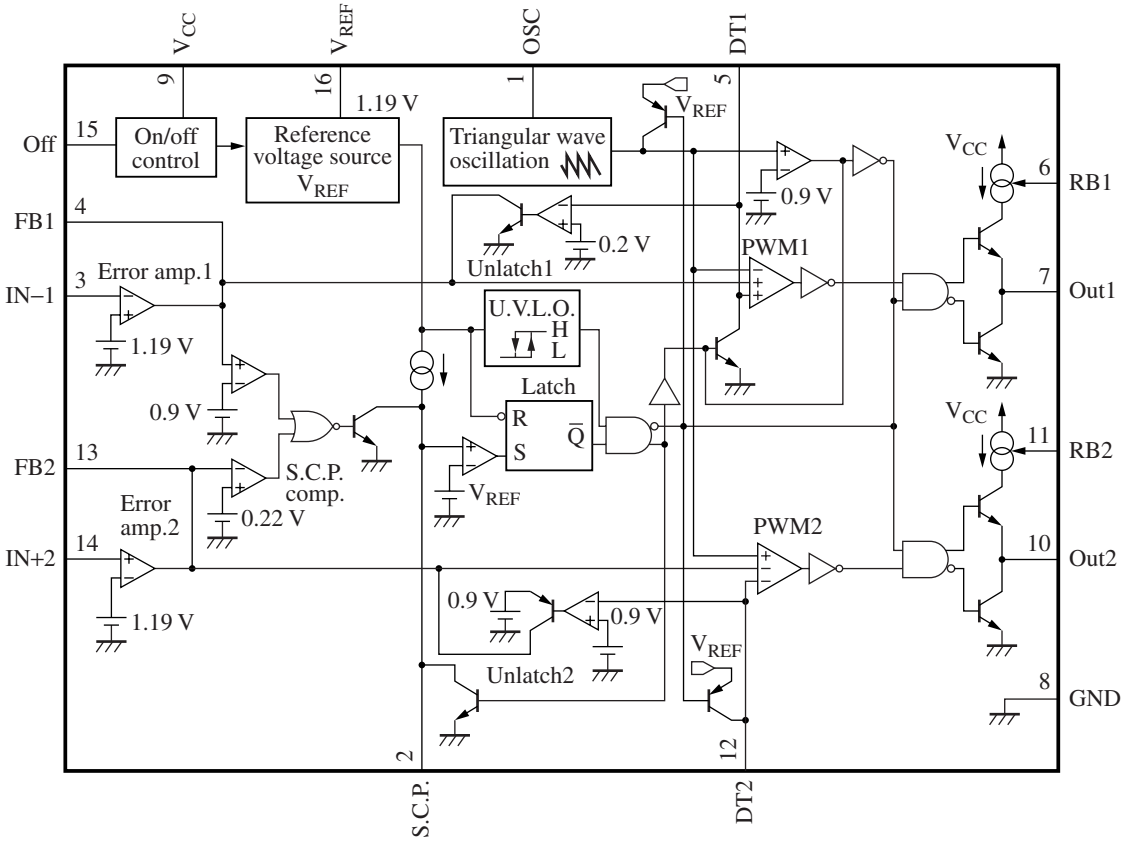
■ Features

- Wide operating supply voltage range (1.8 V to 14 V)
- Incorporating a high precision reference voltage circuit (allowance: ± 2%)
- Control in a wide output frequency range is possible (20 kHz to 1 MHz)
- Built-in wideband error amplifier (single gain bandwidth: 10 MHz typical)
- A built-in timer latch short-circuit protection circuit (charge current: 1.1 µA typical)
- Incorporating an under-voltage lock-out circuit (U.V.L.O.) (circuit operation-starting voltage: 1.67 V typical)
- Dead-time is variable
- Flatness of switching current can be obtained by staggering the turn-on timing of each channel
- Built-in unlatch function
  When DT1 pin is low level or DT2 pin is high level, independent turn-off is possible.
- Incorporating an on/off control function (active-high control input, standby mode current: 1 µA maximum)
- Parallel operation is possible
- Totem pole output
  - Output source-current: –50 mA maximum (Constant current output with a less supply voltage fluctuation is possible by connecting an external resistor to pin 6 and pin 11)
  - Output sink-current: +80 mA maximum

■ Applications

- LCD displays, digital still cameras, and PDAs

■ Block Diagram



■ Pin Descriptions

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	OSC	Pin for connecting a oscillation timing resistor and capacitor	8	GND	Grounding pin
			9	V_{CC}	Power supply voltage application pin
2	S.C.P.	Pin for connecting the time constant setting capacitor for short-circuit protection	10	Out2	Out2 block push-pull type output pin
			11	RB2	Out2 block output source current setting resistor connection pin
3	IN−1	Inverting input pin to error amplifier 1 block			
			12	DT2	PWM2 block dead-time setting pin
4	FB1	Output pin of error amplifier 1 block	13	FB2	Output pin of error amplifier 2 block
5	DT1	PWM1 block dead-time setting pin	14	IN+2	Error amplifier 2 block noninverting input pin
6	RB1	Out1 block output source current setting resistor connection pin			
			15	Off	On/off control pin
7	Out1	Out1 block push-pull type output pin	16	V_{REF}	Reference voltage output pin

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage	V_{CC}	15	V
Off terminal allowable application voltage	V_{OFF}	15	V
IN−1 terminal allowable application voltage *2	V_{IN-1}	6	V
IN+2 terminal allowable application voltage *2	V_{IN+2}	6	V
Supply current	I_{CC}	—	mA
Output source current	$I_{SO(OUT)}$	−50	mA
Output sink current	$I_{SI(OUT)}$	+80	mA
Power dissipation *1	P_D	135	mW
Operating ambient temperature	T_{opr}	−30 to +85	°C
Storage temperature	T_{stg}	−55 to +150	°C

Note) 1. Do not apply external currents or voltages to any pins not specifically mentioned.
For the circuit currents, '+' denotes current flowing into the IC, and '−' denotes current flowing out of the IC.
2. Except for the power dissipation, operating ambient temperature and storage temperature, all ratings are for T_a = 25°C.
3. *1: T_a = 85 °C. For the independent IC without a heat sink. Note that applications must observe the derating curve for the relationship between the IC power consumption and the ambient temperature.
*2: V_{IN-1} , V_{IN+2} = V_{CC} when V_{CC} < 6 V.

■ Recommended Operating Range

Parameter	Symbol	Range	Unit
Supply voltage	V_{CC}	1.8 to 14	V
Off control terminal application voltage	V_{OFF}	0 to 14	V
Output source current	$I_{SO(OUT)}$	−40 (minimum)	mA
Output sink current	$I_{SI(OUT)}$	70 (maximum)	mA
Timing resistance	R_T	1 to 51	kΩ
Timing capacitance	C_T	100 to 10 000	pF
Oscillation frequency	f_{OUT}	20 to 1 000	kHz
Short-circuit protection time constant setting capacitance	C_{SCP}	1 000 (minimum)	pF
Output current setting resistance	R_B	180 to 15 000	Ω

■ Electrical Characteristics at V_{CC} = 2.4 V, C_{REF} = 0.1 µF, T_a = 25°C

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reference voltage block						
Reference voltage	V_{REF}	I_{REF} = − 0.1 mA	1.166	1.19	1.214	V
Input regulation with input fluctuation	Line	V_{CC} = 1.8 V to 14 V	—	15	30	mV
Load regulation	Load	I_{REF} = − 0.1 mA to −1 mA	−20	−5	—	mV
U.V.L.O. block						
Circuit operation start voltage	V_{UON}		1.59	1.67	1.75	V

■ Electrical Characteristics at V_{CC} = 2.4 V, C_{REF} = 0.1 µF, T_a = 25°C (continued)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Error amplifier 1 block						
Input threshold voltage 1	V_{TH1}		1.16	1.19	1.22	V
Input bias current 1	I_{B1}		—	0.2	0.8	µA
High-level output voltage 1	V_{EH1}		0.83	0.93	1.03	V
Low-level output voltage 1	V_{EL1}		—	—	0.2	V
Output source current 1	$I_{SO(FB)1}$		–61	–47	–33	µA
Output sink current 1	$I_{SI(FB)1}$		33	47	61	µA
Error amplifier 2 block						
Input threshold voltage 2	V_{TH2}		1.16	1.19	1.22	V
Input bias current 2	I_{B2}		—	0.2	0.8	µA
High-level output voltage 2	V_{EH2}		0.83	0.93	1.03	V
Low-level output voltage 2	V_{EL2}		—	—	0.2	V
Output source current 2	$I_{SO(FB)2}$		–61	–47	–33	µA
Output sink current 2	$I_{SI(FB)2}$		33	47	61	µA
Oscillator block						
Output off threshold voltage	$V_{TH(OSC)}$		0.8	0.9	1.0	V
Output 1 block						
Oscillation frequency 1	f_{OUT1}	R_T = 12 kΩ, C_T = 330 pF	185	205	225	kHz
Output duty ratio 1	Du_1		73	78	83	%
High-level output voltage 1	V_{OH1}	I_O = –10 mA, R_B = 820 Ω	1.4	—	—	V
Low-level output voltage 1	V_{OL1}	I_O = 10 mA, R_B = 820 Ω	—	—	0.2	V
Output source current 1	$I_{SO(OUT)1}$	V_O = 0.7 V, R_B = 820 Ω	–40	–30	–20	mA
Output sink current 1	$I_{SI(OUT)1}$	V_O = 0.7 V, R_B = 820 Ω	20	—	—	mA
Pull-down resistance 1	R_{O1}		20	30	40	kΩ
Output 2 block						
Oscillation frequency 2	f_{OUT2}	R_T = 12 kΩ, C_T = 330 pF	185	205	225	kHz
Output duty ratio 2	Du_2		72	77	82	%
High-level output voltage 2	V_{OH2}	I_O = –10 mA, R_B = 820 Ω	1.4	—	—	V
Low-level output voltage 2	V_{OL2}	I_O = 10 mA, R_B = 820 Ω	—	—	0.2	V
Output source current 2	$I_{SO(OUT)2}$	V_O = 0.7 V, R_B = 820 Ω	–40	–30	–20	mA
Output sink current 2	$I_{SI(OUT)2}$	V_O = 0.7 V, R_B = 820 Ω	20	—	—	mA
Pull-down resistance 2	R_{O2}		20	30	40	kΩ
PWM1 block						
Output full-off input threshold voltage 1	$V_{T0\text{-}1}$	Duty = 0%	—	0.28	0.30	V
Output full-on input threshold voltage 1	$V_{T100\text{-}1}$	Duty = 100%	0.65	0.72	—	V
Input current 1	I_{DT1}	V_{DT1} = 0.5 V	–1.1	– 0.5	—	µA

■ Electrical Characteristics at V_{CC} = 2.4 V, C_{REF} = 0.1 µF, T_a = 25 °C (continued)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
PWM2 block						
Output full-off input threshold voltage 2	V_{T0-2}	Duty = 0%	0.65	0.72	—	V
Output full-on input threshold voltage 2	V_{T100-2}	Duty = 100%	—	0.28	0.30	V
Input current 2	I_{DT2}	V_{DT2} = 0.2 V	−1.1	− 0.5	—	µA
Unlatch circuit 1 block						
Input threshold voltage 1	V_{THUL1}		0.15	0.20	0.25	V
Unlatch circuit 2 block						
Input threshold voltage 2	V_{THUL2}		0.8	0.9	1.0	V
Short-circuit protection circuit block						
Input standby voltage	V_{STBY}		—	60	120	mV
Input threshold voltage 1	V_{THPC1}		0.8	0.9	1.0	V
Input threshold voltage 2	V_{THPC2}		0.17	0.22	0.27	V
Input latch voltage	V_{IN}		—	60	120	mV
Charge current	I_{CHG}	V_{SCP} = 0 V	−1.43	−1.1	− 0.77	µA
On/off control block						
Input threshold voltage	$V_{ON(TH)}$		0.8	1.0	1.3	V
Whole device						
Output off consumption current	$I_{CC(OFF)}$	R_B = 820 Ω, duty = 0%	—	7.0	9.8	mA
Latch mode consumption current	$I_{CC(LA)}$	R_B = 820 Ω	—	5.6	7.8	mA
Standby current	$I_{CC(SB)}$		—	—	1	µA

• Design reference data

Note) The characteristics listed below are theoretical values based on the IC design and are not guaranteed.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reference voltage block						
V_{REF} temperature characteristics	V_{REFdT}	T_a = −30°C to +85°C	−1	—	+1	%
Over-current protection drive current	I_{OC}		—	−11	—	mA
U.V.L.O. block						
Reset voltage	V_R		—	0.8	—	V
Error amplifier 1/2 blocks						
V_{TH} temperature characteristics	V_{THdT}	T_a = −30°C to +85°C	− 0.3	—	+ 0.3	mV/°C
Open-loop gain	A_V		—	57	—	dB
Single gain bandwidth	f_{BW}		—	10	—	MHz
Output 1/2 blocks						
RB terminal voltage	V_B		—	0.36	—	V
Frequency supply voltage characteristics	f_{dV}		−1	—	+1	%
Frequency temperature characteristics	f_{dT}		−3	—	+3	%

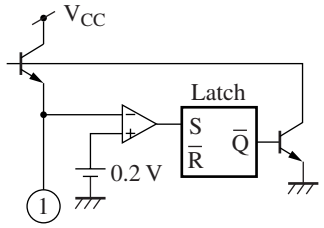
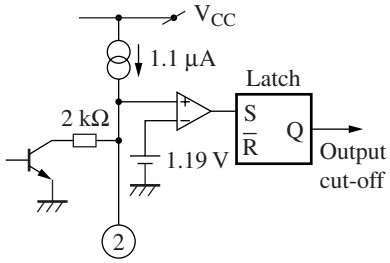
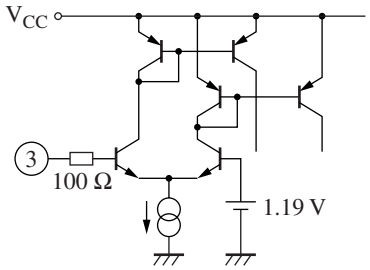
■ Electrical Characteristics at V_{CC} = 2.4 V, C_{REF} = 0.1 µF, T_a = 25°C (continued)

• Design reference data (continued)

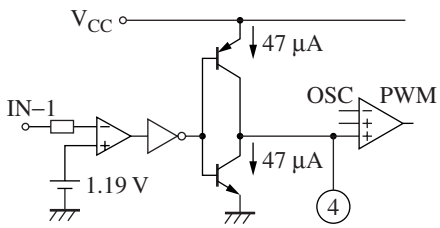
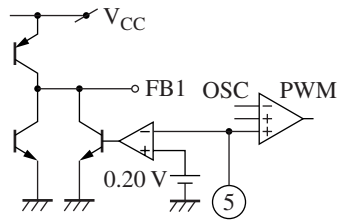
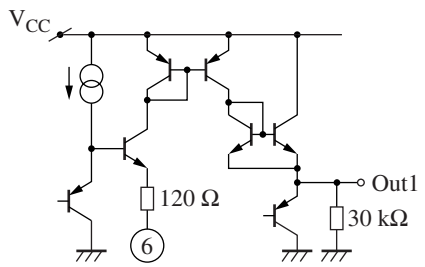
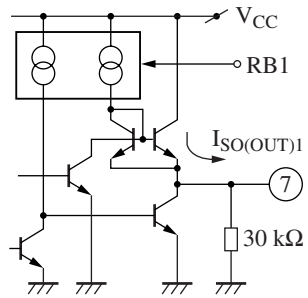
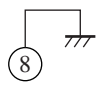
Note) The characteristics listed below are theoretical values based on the IC design and are not guaranteed.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Short-circuit protection block						
Comparator threshold voltage	V_{THL}		—	1.19	—	V
On/off control block						
Off terminal current	I_{OFF}		—	23	—	µA

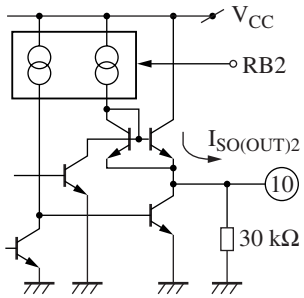
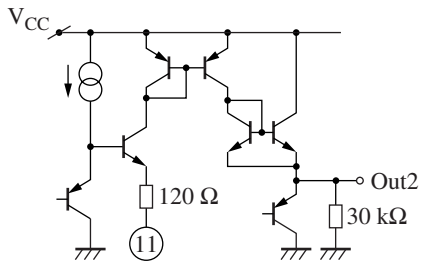
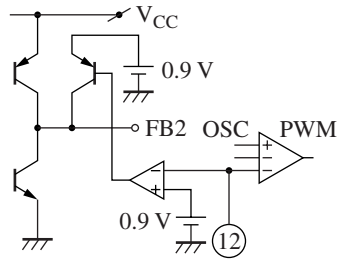
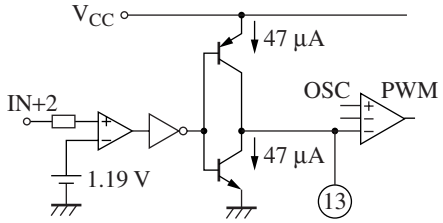
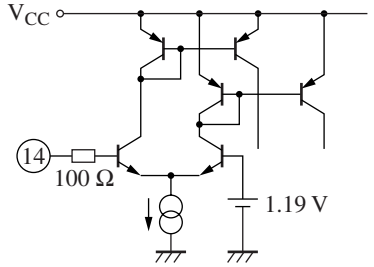
■ Terminal Equivalent Circuits

Pin No.	Equivalent circuit	Description	I/O
1		OSC: The terminal used for connecting a timing capacitor/resistor to set oscillation frequency. Use a capacitance value within the range of 100 pF to 10000 pF and a resistance value within the range of 1 kΩ to 51 kΩ. Use an oscillation frequency in the range of 20 kHz to 1 MHz. In a parallel synchronous operation, the channel 2 output stops when this pin becomes 0.9 V or more. (Refer to the "Application Notes, [7]" section.)	O
2		S.C.P.: The terminal for connecting a capacitor to set the time constant of the timer latch short-circuit protection circuit. Use a capacitance value in the range of 1000 pF or more. The charge current I_{CHG} is 1.1 µA typical.	O
3		IN−1: The inverting input pin for error amplifier 1 block.	I

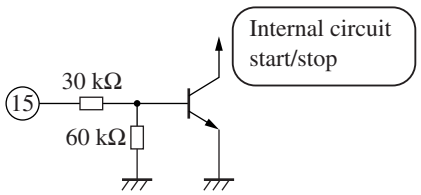
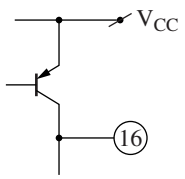
■ Terminal Equivalent Circuits (continued)

Pin No.	Equivalent circuit	Description	I/O
4		FB1: The output pin for error amplifier 1 block. The source current is –47 µA and the sink current is 47 µA. Correct the frequency characteristics of the gain and the phase by connecting a resistor and a capacitor between this terminal and GND.	O
5		DT1: The pin for setting channel 1 output maximum duty ratio. If this terminal is set at a voltage of 0.20 V or less, FB1 terminal becomes low-level voltage and the protective function for channel 1 output short-circuit will stop (Unlatch function).	I
6		RB1: The pin for connecting a resistor for setting channel 1 output current. Use a resistance value in the range of 180 Ω to 15 kΩ. The terminal voltage is 0.36 V (at R_{B1} = 820 Ω).	I
7		Out1: The pin is push-pull type output terminal. The absolute maximum ratings of output current are –50 mA for the source current and +80 mA for the sink current. A constant current output with less fluctuation with power supply voltage and dispersion can be obtained by the resistor externally attached to RB1 pin. $I_{SO(OUT)1} = 68 \times \frac{V_{RB1}}{R_{B1}}$ [A]	O
8		GND: Grounding terminal	—
9		V_{CC}: The supply voltage application terminal Use the operating supply voltage in the range of 1.8 V to 14 V.	—

■ Terminal Equivalent Circuits (continued)

Pin No.	Equivalent circuit	Description	I/O
10		Out2: The pin is push-pull type output terminal. The absolute maximum ratings of output current are –50 mA for the source current and +80 mA for the sink current. A constant current output with less fluctuation with power supply voltage and dispersion can be obtained by the resistor externally attached to RB2 pin. $I_{SO(OUT)2} = 68 \times \frac{V_{RB2}}{R_{B2}}$ [A]	O
11		RB2: The pin for connecting a resistor for setting channel 2 output current. Use a resistance value in the range of 180 Ω to 15 kΩ. The terminal voltage is 0.36 V (at R_{B2} = 820 Ω).	I
12		DT2: The pin for setting channel 2 output maximum duty ratio. If this terminal is set at a voltage of 0.9 V or more, FB2 terminal becomes high-level voltage and the protective function for channel 2 output short-circuit will stop (Unlatch function).	I
13		FB2: The output pin for error amplifier. The source current is –47 µA and the sink current is 47 µA. Correct the frequency characteristics of the gain and the phase by connecting a resistor and a capacitor between this terminal and GND.	O
14		IN+2: The noninverting input pin for error amplifier 2 block.	I

■ Terminal Equivalent Circuits (continued)

Pin No.	Equivalent circuit	Description	I/O
15		Off: The terminal for on/off control. High-level input: Normal operation (V_{OFF} > 1.3 V) Low-level input: Standby state (V_{OFF} < 0.8 V) The total current consumption in the standby state can be suppressed to a value of 1 µA or less.	I
16		V_{REF}: The output terminal for the internal reference voltage. The reference voltage is 1.19 V (allowance: ± 2%) at V_{CC} = 2.4 V and I_{REF} = − 0.1 mA. Connect a capacitor of 0.01 µF or more between V_{REF} and GND for phase compensation.	O

■ Usage Notes

[1] The loss, P of this IC increases in proportion to the supply voltage. Use the IC so as not to exceed the allowable power dissipation of package, P_D .

Reference formula:

$P = (V_{CC} - V_{BEQ1}) \times I_{SO(OUT)1} \times Du_1 + (V_{CC} - V_{BEQ2}) \times I_{SO(OUT)2} \times Du_2 + V_{CC} \times I_{CC} < P_D$

V_{BEQ1} : Base-emitter voltage of npn transistor Q1

$I_{SO(OUT)1}$: Out1 terminal output source current (set by RB1, $I_{SO(OUT)1}$ = 40 mA maximum at RB1 = 820 Ω)

Du_1 : Output1 duty ratio

V_{BEQ2} : Base-emitter voltage of npn transistor Q2

$I_{SO(OUT)2}$: Out2 terminal output source current (set by RB2, $I_{SO(OUT)2}$ = 40 mA maximum at RB2 = 820 Ω)

Du_2 : Output2 duty ratio

I_{CC} : V_{CC} terminal current (8.0 mA maximum where V_{CC} = 2.4 V)

[2] Since the output 2 of the AN8017SA is assuming the bipolar transistor driving, it is necessary to pay attention to the following points when an n-channel MOSFET is driven directly.

1. Select an n-channel MOSFET having a low input capacitance

The AN8017SA is of the constant current (50 mA maximum) output source current type circuit assuming the bipolar transistor driving. Also, its sink current capability is around 80 mA maximum. For those reason, it is necessary to pay attention to the increase of loss due to the extension of the output rise time and the output fall time.

If any problem arises, there is a method to solve it by amplifying with inverters as shown in figure 1.

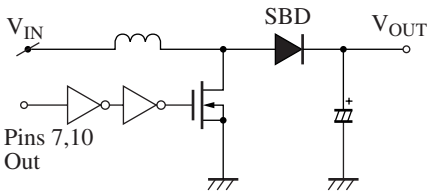


Figure 1. Output bootstrap circuit example

■ Usage Notes (continued)

2. Select an n-channel MOSFET having a low gate threshold value

The high-level output voltage of out pin of the AN8017SA is V_{CC} − 1.0 V minimum, so that it is necessary to select a low V_T MOSFET having a sufficiently low on-state resistance in accordance with the using operating supply voltage.

If a larger V_{GS} is desired, there is a method to apply the double-voltage of the input to the IC's V_{CC} pin by using the transformer as shown in figure 2.

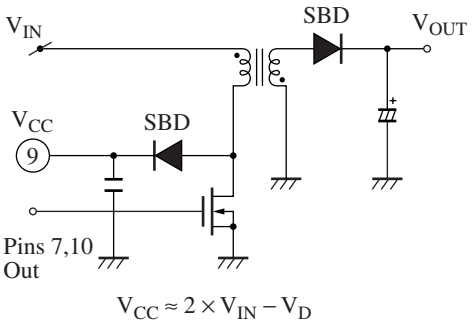
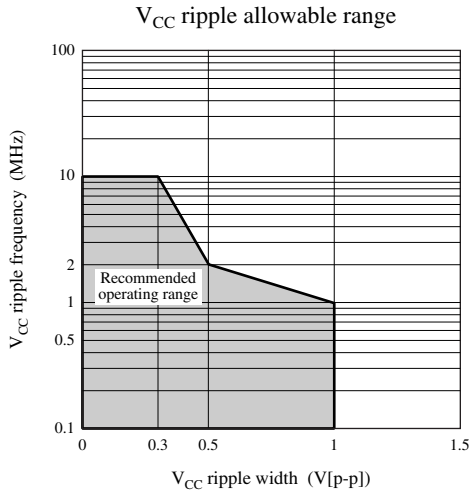


Figure 2. Gate drive voltage increasing method

[3] In order to realize a low noise and high efficiency, care should be taken in the following points in designing the board layout.

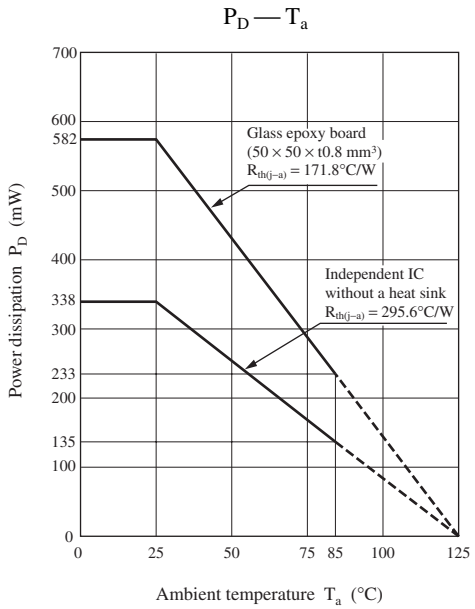
1. The wiring for ground line should be taken as wide as possible and grounded separately from the power system.
2. The input filter capacitor should be arranged in a place as close to V_{CC} and GND pin as possible so as not to allow switching noise to enter into the IC inside.
3. The wiring between the Out terminal and switching device (transistor or MOSFET) should be as short as possible to obtain a clean switching waveform.
4. In wiring the detection resistor of the output voltage, the wiring for the low impedance side should be longer.

[4] There is a case in which this IC does not start charging to the S.C.P. capacitor when the output is short-circuited due to the malfunction of U.V.L.O. circuit biased by V_{CC} that has ripples generated by turning on and off of the switching transistor. The allowable range of the V_{CC} ripple is as shown in the following figure. Reduce the V_{CC} ripple by inserting a capacitor near the V_{CC} terminal and GND terminal of this IC so that the V_{CC} ripple is in this allowable range. However, this allowable range is design reference value and not the guaranteed value.



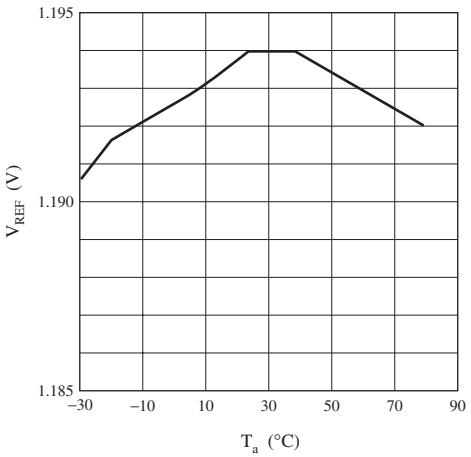
■ Application Notes

[1] P_D — T_a curves of SSOP016-P-0225A

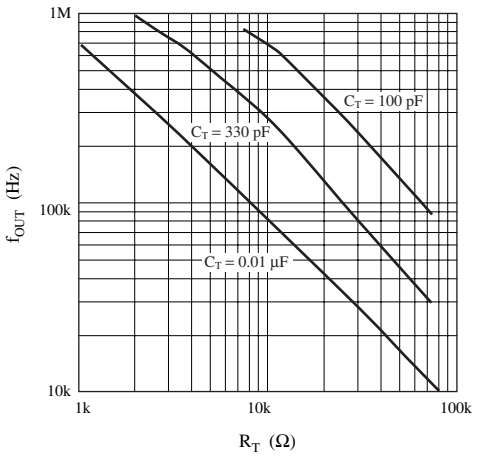


[2] Main characteristics

V_{REF} temperature characteristics



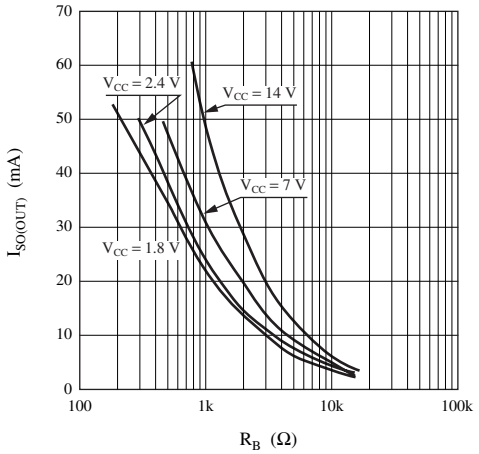
Frequency characteristics



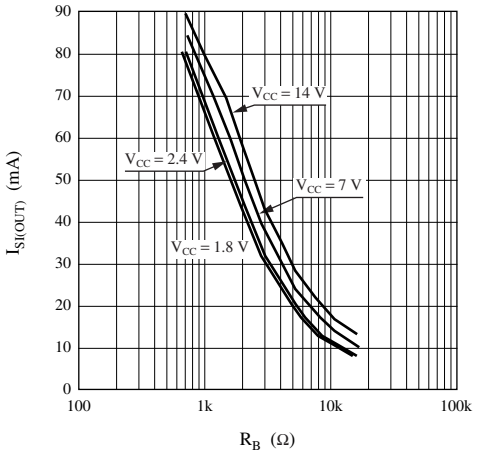
■ Application Notes (continued)

[2] Main characteristics (continued)

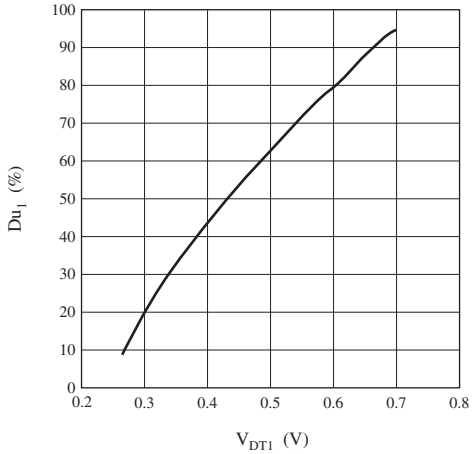
$I_{SO(OUT)}$ — R_B



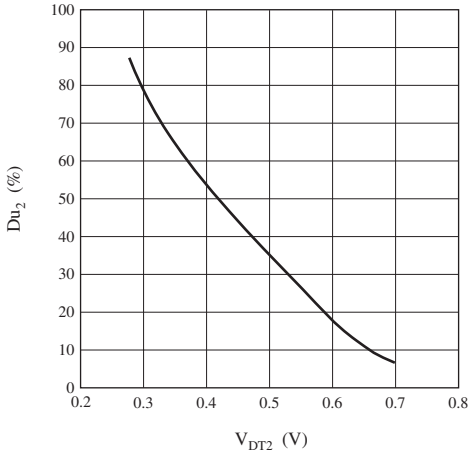
$I_{SI(OUT)}$ — R_B



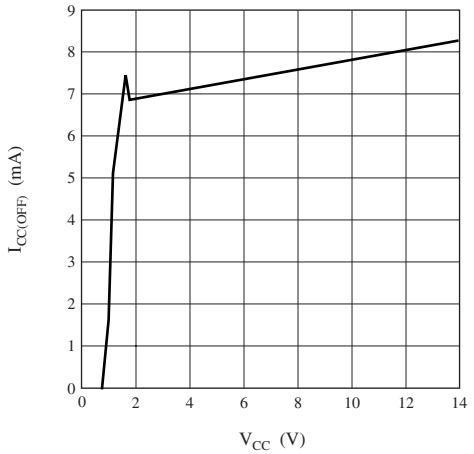
Du_1 — V_{DT1}



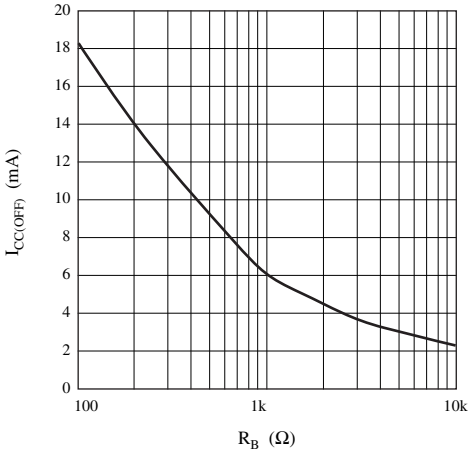
Du_2 — V_{DT2}



$I_{CC(OFF)}$ — V_{CC}

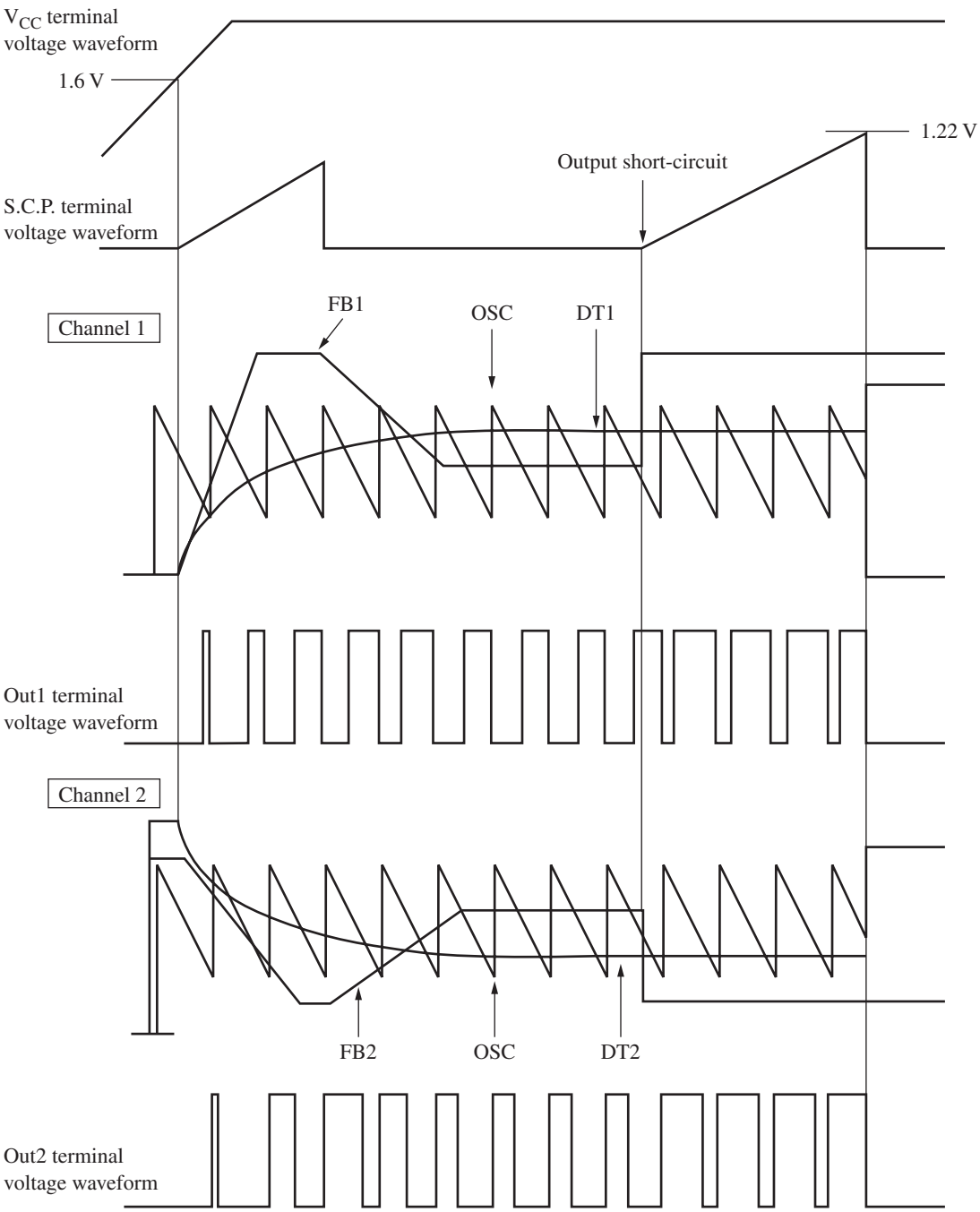


$I_{CC(OFF)}$ — R_B



■ Application Notes (continued)

[3] Timing chart



■ Application Notes (continued)

[4] Function descriptions

1. Reference voltage block

This block is composed of the band gap circuit, and outputs the temperature compensated 1.19 V reference voltage. The reference voltage is stabilized when the supply voltage is 1.8 V or more. The reference voltage is also used as the reference voltage for the error amplifier 1 block and the error amplifier 2 block.

2. Triangular wave oscillation block

The sawtooth-waveform-like triangular wave having a peak of approximately 0.7 V and a trough of approximately 0.2 V can be generated by connecting the timing capacitor and resistor to the OSC terminal (pin 1). The oscillation frequency can be freely set by the value of C_T and R_T to be connected externally. The usable oscillation frequency is from 20 kHz to the maximum 1 MHz. The triangular wave is connected with the inverting input of PWM comparator for channel 1 side and the noninverting input of PWM comparator for channel 2 side within the IC inside. And refer to the experimentally determined graph of the frequency characteristics provided in the main characteristics section.

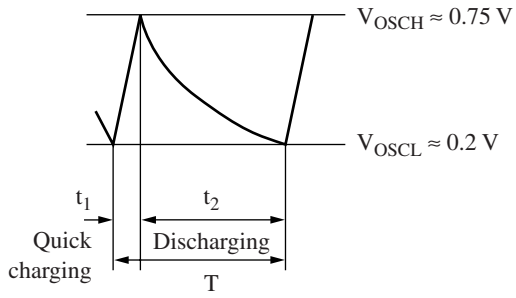


Figure 1. Tiangular wave oscillation waveform

3. Error amplifier 1 block

The output voltage of DC-DC converter is detected by the npn-transistor-input type error amplifier and the amplified signal is input to the PWM comparator. The internal reference voltage 1.19 V is given to the noninverting input.

Also, it is possible to perform the gain setting and the phase compensation arbitrarily by connecting a resistor and a capacitor from the FB1 terminal (pin 4) to GND in series.

The output voltage V_{OUT1} can be set by making connection as shown in figure 2.

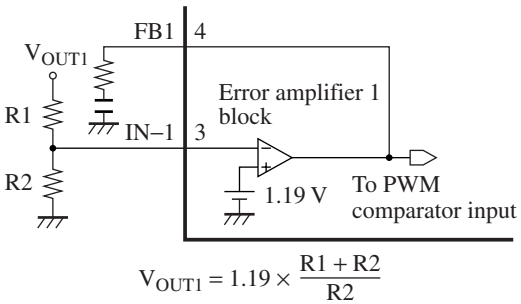


Figure 2. Connection method of error ampifier 1 block (Step-up output)

4. Error amplifier 2 block

The output voltage of DC-DC converter is detected by the npn-transistor-input type error-amplifier and the amplified signal is input to the PWM comparator. The internal reference voltage 1.19 V is given to the noninverting input.

Also, it is possible to perform the gain setting and the phase compensation arbitrarily by connecting a resistor and a capacitor from the FB2 terminal (pin 13) to GND in series.

The output voltage V_{OUT2} can be set by making connection as shown in figure 3.

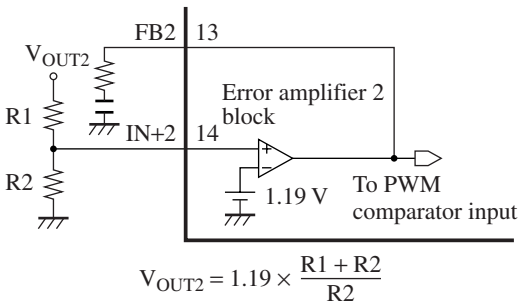


Figure 3. Connection method of error ampifier 2 block (Step-up output)

■ Application Notes (continued)

[4] Function descriptions (continued)

5. Timer latch short-circuit protection circuit

This circuit protects the external main switching devices, flywheel diodes, and choke coils, etc. from destruction or deterioration if overload or short-circuit condition of power supply output lasts for a certain time.

The timer latch short-circuit protection circuit detects the output level of the error amplifier. When the output voltage of DC-DC converter drops and the output level of error amplifier 1 block exceeds 0.9 V or the output level of error amplifier 2 block exceeds 0.22 V, the low-level output is given and the timer circuit is actuated to start the charge of the external protection-enable capacitor.

If the output of the error amplifier does not return to a normal voltage range by the time when the voltage of this capacitor reaches 1.22 V, it sets the latch circuit, and cuts off the output drive transistor, and sets the dead-time to 100%.

6. Low input voltage malfunction prevention circuit (U.V.L.O.)

This circuit protects the system from destruction or deterioration due to control malfunction when the supply voltage is low in the transient state of power on/off.

The low input voltage malfunction prevention circuit detects the internal reference voltage which changes according to the supply voltage level. Until the supply voltage reaches 1.67 V during its rise time, it cuts off the output drive transistor, and sets the dead-time to 100%. At the same time, it holds the S.C.P. terminal (pin 2) and DT1 terminal (pin 5) to low-level and the OSC terminal (pin 1) and DT2 terminal (pin 12) to high-level.

7. PWM comparator block

The PWM comparator controls the on-period of the output pulse according to the input voltage. The PWM1 and PWM2 block are reverse logic relation.

The PWM1 block turns on the output transistor during the period when the triangular wave of OSC terminal (pin 1) is lower than any lower one of the FB1 (pin 4) terminal voltage and the DT1 (pin 5) terminal voltage.

The PWM2 block turns on the output transistor during the period when the triangular wave of OSC terminal (pin 1) is higher than any higher one of the FB2 (pin 13) terminal voltage and the DT2 (pin 12) terminal voltage.

The maximum duty ratio is variable from the outside.

Also, the soft start which gradually extends on-period of the output pulse is activated by connecting a capacitor in parallel with the resistor-dividing for the maximum duty ratio setting.

8. Unlatch block

The unlatch circuit 1 block fixes the FB1 terminal (pin 4) at low-level at the DT1 terminal (pin 5) is 0.20 V or less. The unlatch circuit 2 block fixes the FB2 terminal (pin 13) at high-level at the DT2 terminal (pin 12) is 0.9 V or less. Consequently, by controlling the DT terminal voltage, it is possible to operate only one channel or to start and stop each channel in any required sequence.

9. Output 1 block

This block uses a totem pole type output circuit. By connecting the current setting resistor to the RB1 terminal, it is possible to arbitrarily set a constant-current source-output having a small fluctuation with the supply voltage.

The available constant-current source-output is up to 50 mA. The breakdown voltage of output terminal is 15 V.

10. Output 2 block

This block uses a totem pole type output circuit. By connecting the current setting resistor to the RB2 terminal, it is possible to arbitrarily set a constant-current source-output having a small fluctuation with the supply voltage.

The available constant-current source-output is up to 50 mA. The breakdown voltage of output terminal is 15 V.

■ Application Notes (continued)

[5] About logic of PWM block

The logic for channel 1 and channel 2 of this IC is reversed. Thereby an input current flatness is realized. At the same time, noise can be suppressed to a lower level by staggering the turn on timing.

The PWM1 block turns on the output transistor during the period when the triangular wave of the OSC terminal (pin 1) is lower than both of the FB1 (pin 4) terminal voltage and the DT1 (pin 5) terminal voltage.

The PWM2 block turns on the output transistor during the period when the triangular wave of the OSC terminal (pin 1) is higher than both of the FB2 (pin 13) terminal voltage and the DT2 (pin 12) terminal voltage.

(Refer to figure 4.)

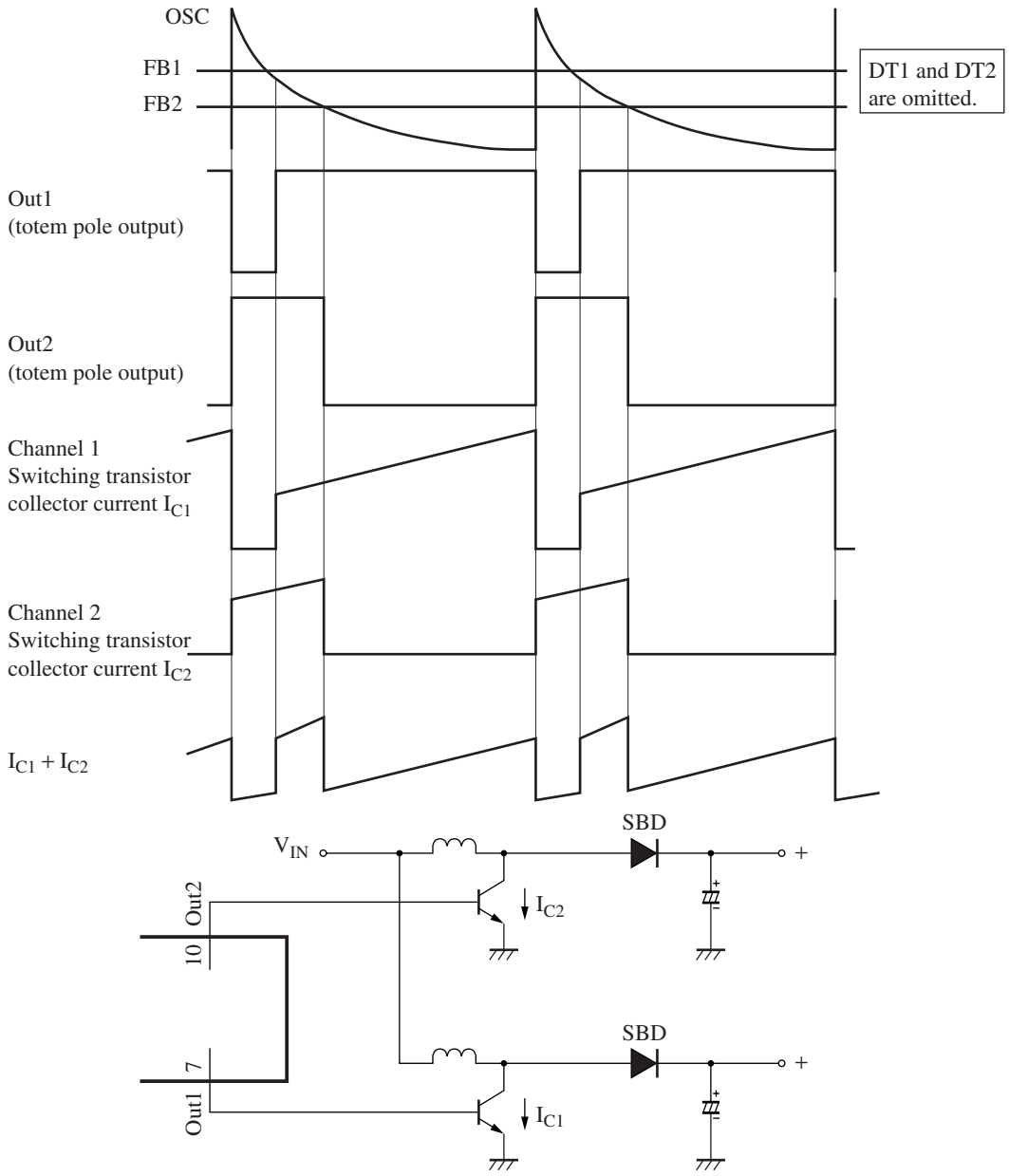


Figure 4. PWM logic explanation chart

■ Application Notes (continued)

[6] Time constant setting method for timer latch short-circuit protection circuit

The constructional block diagram of protection latch circuit is shown in figure 6. The comparator for short-circuit protection compares the error amplifier 1 output FB1 with the reference voltage of 0.9 V for channel 1 side, and the error amplifier 2 output FB2 with the reference voltage of 0.18 V for channel 2 side at all the time.

When the load conditions of DC-DC converter output is stabilized, there is no fluctuation of error amplifier output and the short-circuit protection comparator also keeps the balance. At this moment, the output transistor Q1 is in the conductive state and the S.C.P. terminal is held to approximately 60 mV.

When the load conditions for channel 1 side suddenly change and high-level signal (0.9 V or more) is input from the error amplifier 1 block to the short-circuit protection comparator, the short-circuit protection comparator outputs the low-level signal to cut off the output transistor Q1. Also, when the load conditions for channel 2 side suddenly change and low-level signal (0.22 V or less) is inputted from the error amplifier 2 block to the short-circuit protection comparator, the short-circuit protection comparator outputs the low-level signal to cut off the output transistor Q1. The capacitor C_{SCP} connected to the S.C.P. terminal starts charging. When the external capacitor C_{SCP} has been charged to approximately 1.19 V with the constant current of approximately 1.1 µA, the latch circuit is set, the output terminal is fixed to low-level, and the dead-time is set to 100%. Once the latch circuit is set, the S.C.P. terminal is discharged to approximately 40 mV. However, the latch circuit is not reset unless the power for the latch circuit is turned off or restarted by the on/off control.

$$1.19\ V = I_{CHG} \times \frac{t_{PE}}{C_{SCP}}$$

$$\therefore\ t_{PE}\ [s] = 1.08 \times C_{SCP}$$

When the power supply is turned on, the output is considered to be short-circuited state so that the S.C.P. terminal voltage starts charging. It is necessary to set the external capacitor so as to start up the DC-DC converter output voltage before setting the latch circuit in the later stage. Especially, pay attention to the delay of the start-up time when applying the soft-start.

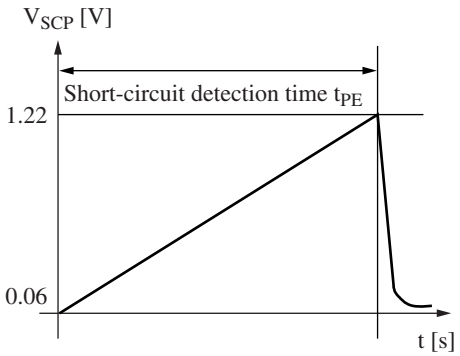


Figure 5. S.C.P. terminal charging waveform

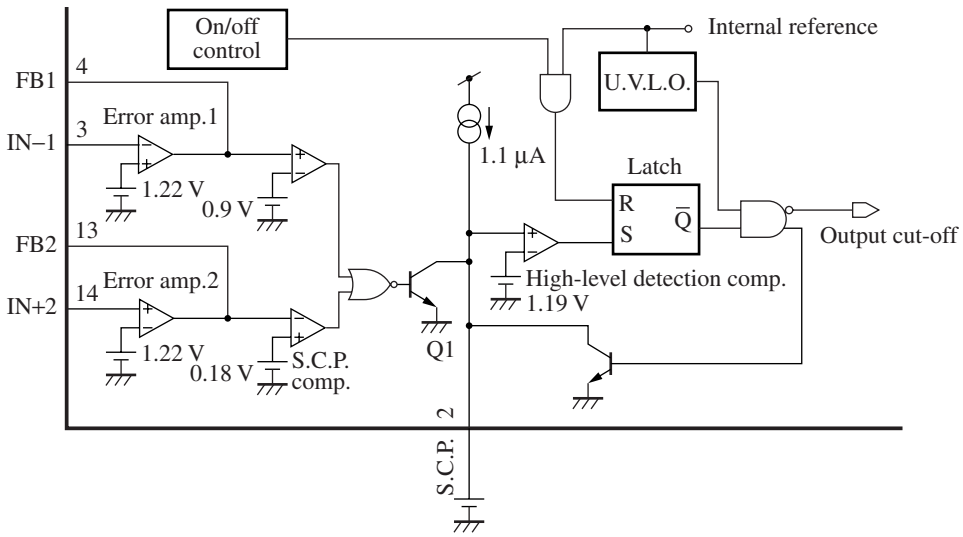


Figure 6. Short-circuit protection circuit

■ Application Notes (continued)

[7] Parallel synchronous operation of multiple ICs

Multiple instances of this IC can be operated in parallel. If the OSC terminals (pin 1) and Off terminals (pin 15) are connected to each other as shown in figure 7, the ICs will operate at the same frequency.

It is possible to operate this IC (the AN8017SA) with the two-channel 1.8-volt DC-DC converter control IC AN8018SA (open-collector output/each single-channel totem pole output) in parallel synchronous mode.

1. Usage notes
   1) The parallel synchronous operation with the single-channel 1.8-volt DC-DC converter control IC AN8016SH/AN8016NSH is not possible.
   2) The remote on/off with the single IC itself is not possible. Only the simultaneous remote on/off of all ICs is possible.

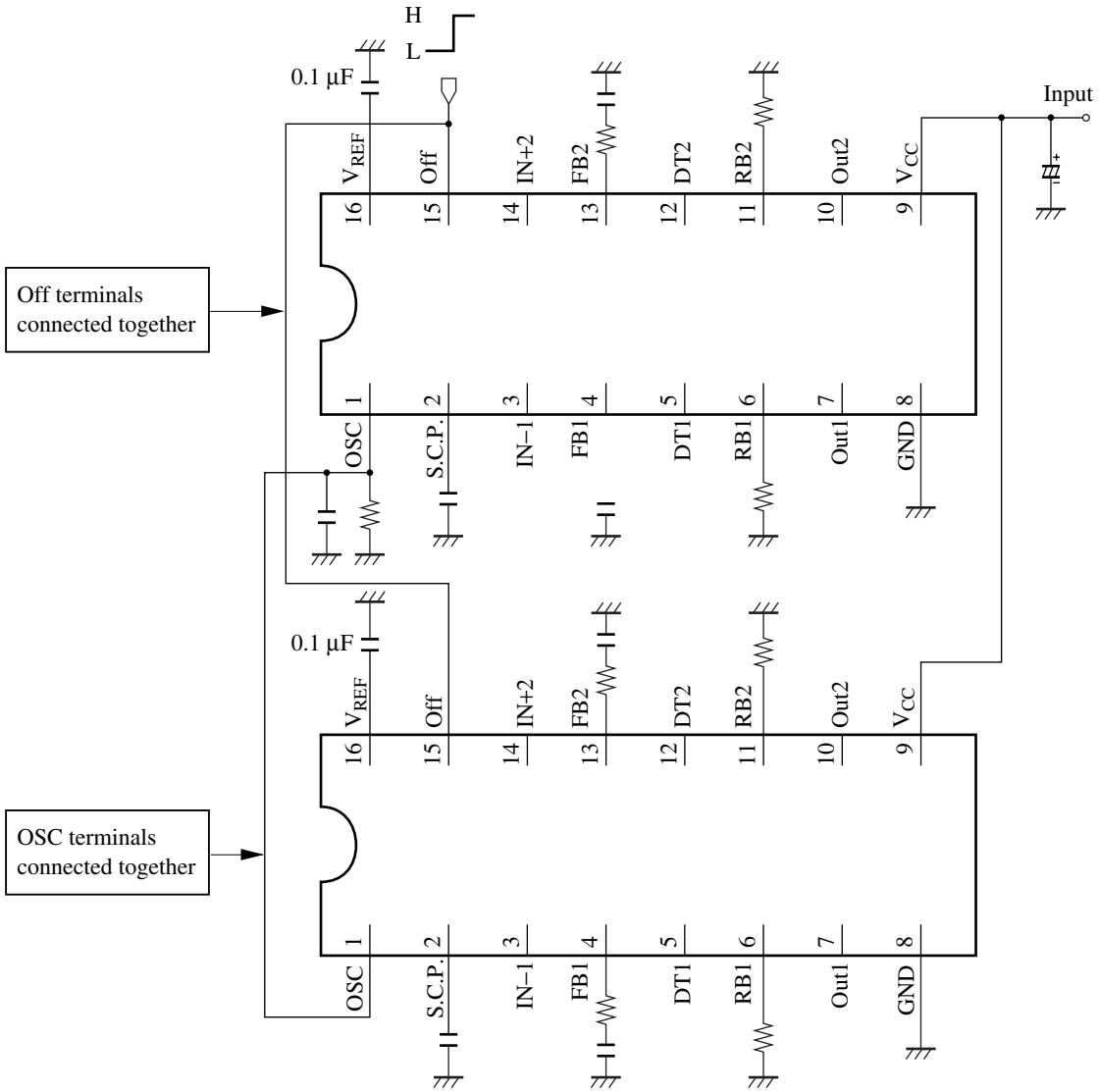


Figure 7. Slave operation circuit example

■ Application Notes (continued)

[7] Parallel synchronous operation of multiple ICs (continued)

2. About the operation of short-circuit protection at parallel synchronous operation

In the case of the operation in parallel, if the single output (or multiple outputs) of them is short-circuited and the timer latch is applied to the IC which has that output, the output of other ICs will be also shut down.

In figure 8, if the timer latch is applied to IC-2, Q1 turns on and the OSC terminal (pin 1) is raised to approximately 1.1 V. Then channel 1 of IC-1 logically turns off, and then for channel 2, the output of comparator whose reference voltage is 0.9 V becomes high-voltage and Out2 is forced to go off. The same goes with the case when the timer latch is applied to IC-1.

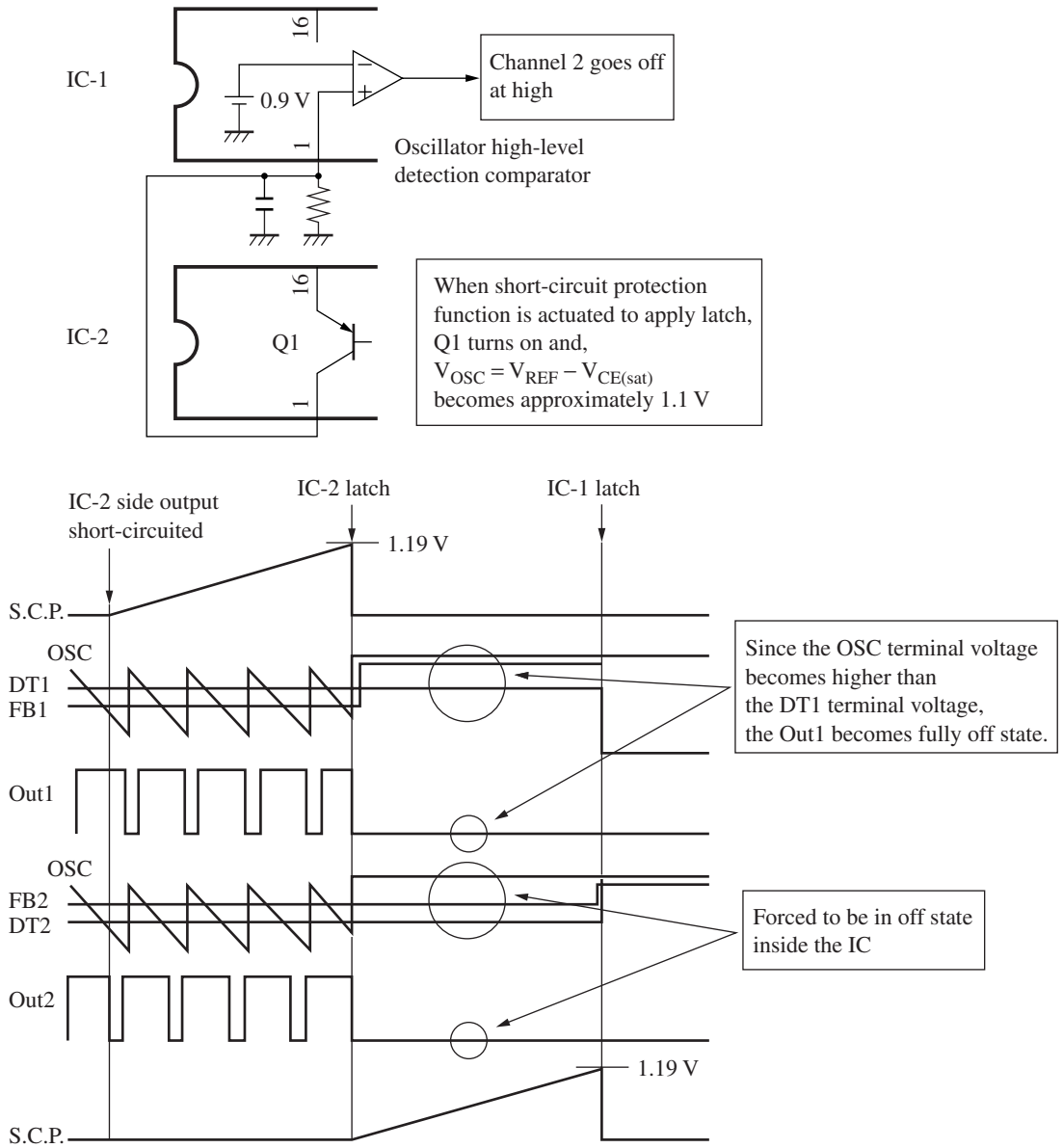


Figure 8. Operation of short-circuit protection at parallel synchronous operation

■ Application Notes (continued)

[8] Setting of Off-terminal connection resistor

The start circuit starts its operation when Q1 is turned on. In an organization in which Q1 turns off/on when Q2 turns on/off in figure 9, the input voltage V_{IN} at which the start circuit operates is obtained by the equation:

$V_{IN} = V_{BEQ1} \times (R_{OFF} + R1 + R2) / R2$

Therefore, R_{OFF} can be set by:

$R_{OFF} = R2 \cdot V_{IN} / V_{BEQ1} - R1 - R2$

Also, in case of limiting the Off terminal current by R_{OFF}, set it by the above equation. However, take the values as:

$V_{BEQ1} = 0.7$ V (T = 25°C)

V_{BEQ1} fluctuation with temperature: −2 mV/°C

Temperature coefficient of R1 and R2: +6 000 PPM/°C

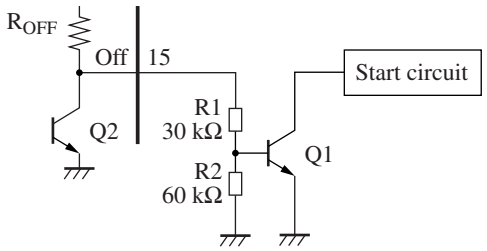


Figure 9. Off terminal peripheral circuit

[9] Sequential operation

It is possible to turn on/off the output of DC-DC converter individually by turning on/off Q1 and Q2 as shown in figure 10. However, pay particular attention to the current flowing into the V_{REF} terminal when Q2 is turned off since sink capability of V_{REF} terminal is approximately 100 µA.

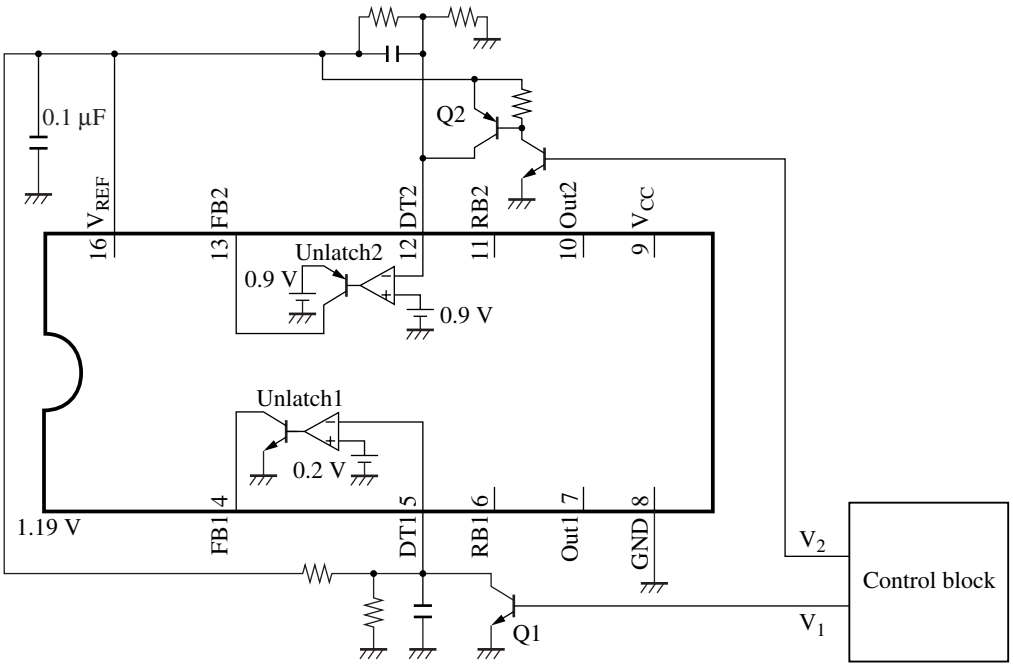
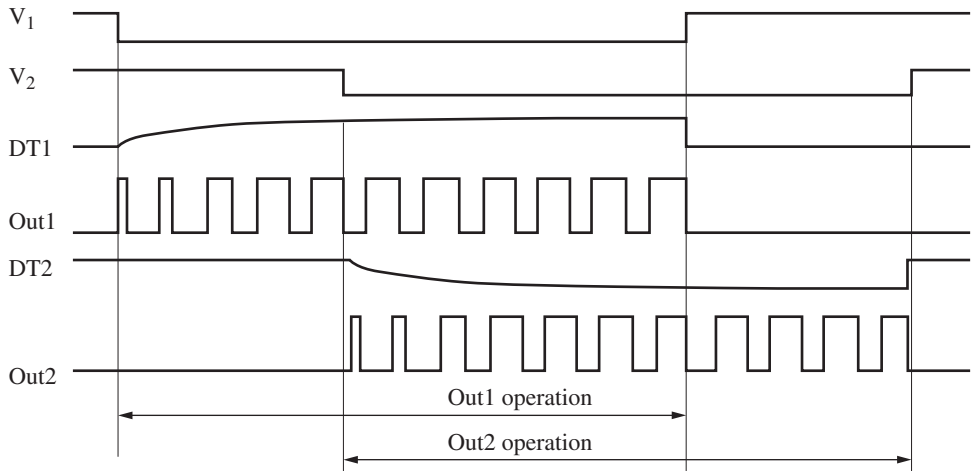


Figure 10

■ Application Notes (continued)

[9] Sequence operation (continued)



Out1: Off at DT1 < 0.2 V Out2: Off at DT2 > 0.9 V

Operation when each channel is turned on/off independently

[10] Error amplifier phase-compensation setting method

The equivalent circuit of error amplifier is shown in figure 11.

The transfer function is:

$$H = \frac{1 / \{S (C_{E1} + C_{O1})\}}{R_{E1} + 1 / \{S (C_{E1} + C_{O1})\}} = \frac{1}{SC_{O1} \cdot R_{E1} + 1} \quad (\text{from } C_{E1} << C_{O1})$$

The cut-off frequency is variable by changing the externally attached phase compensation capacitor C_{O1} .

Adjust by inserting a resistor R_{O1} between the FB1 terminal and C_{O1} in series as shown in figure 12 when it is required to have a gain on the high frequency side or desired to lead a phase.

The transfer function is:

$$H = \frac{SC_{O1} \cdot R_{O1} + 1}{SC_{O1} (R_{O1} + R_{E1}) + 1} \quad (\text{from } C_{E1} << C_{O1})$$

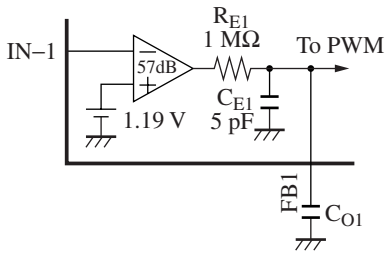


Figure 11. Error amplifier equivalent circuit

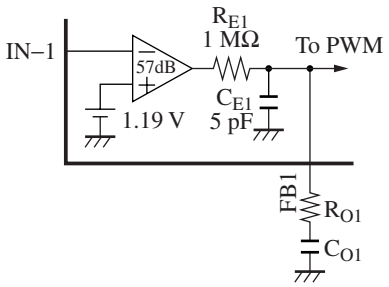
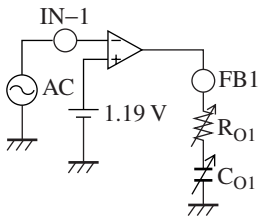


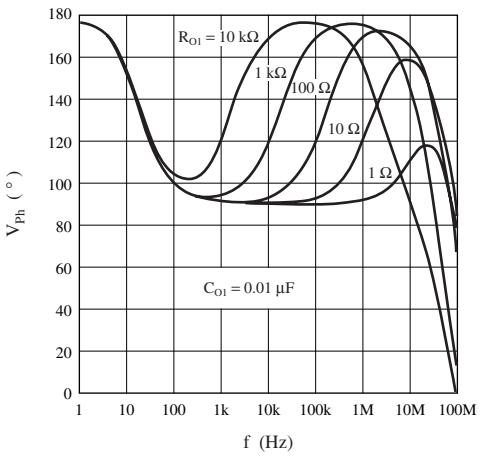
Figure 12. Error amplifier equivalent circuit (R_{O1} inserted)

■ AC Analysis Result

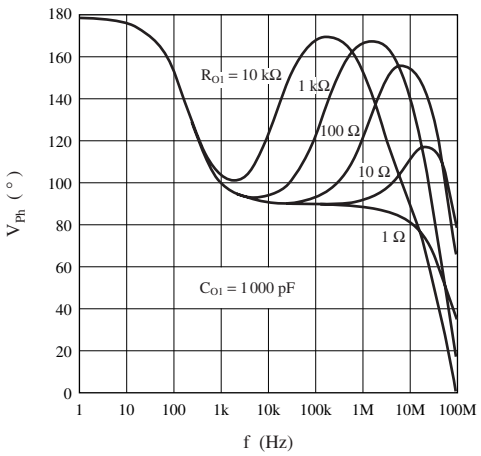
• Simulation circuit



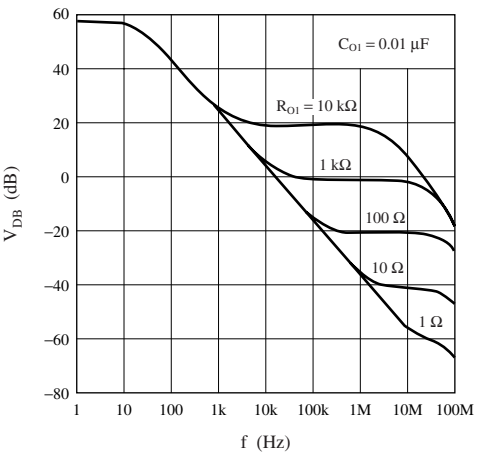
f — V_{Ph}



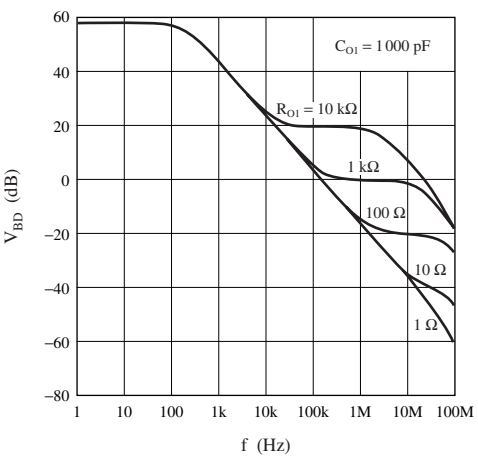
f — V_{Ph}



f — V_{BD}

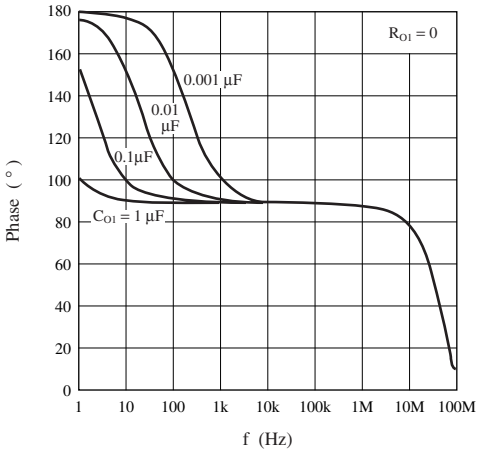


f — V_{BD}

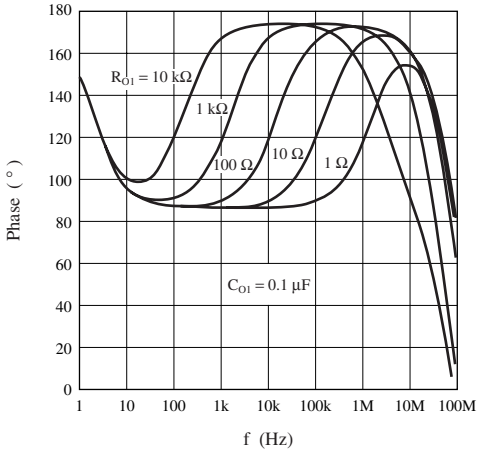


■ AC Analysis Result (continued)

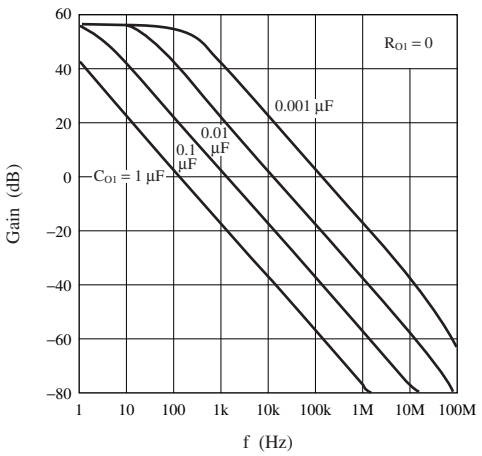
f — Phase



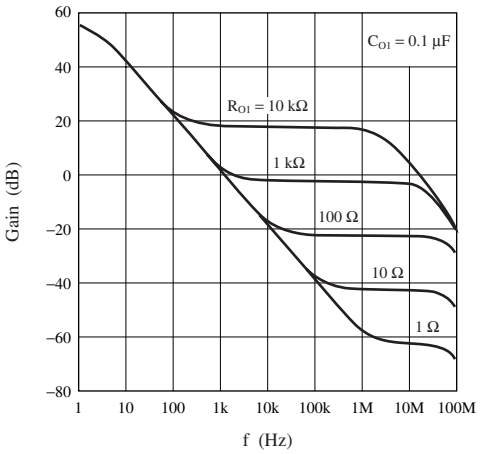
f — Phase



f — Gain

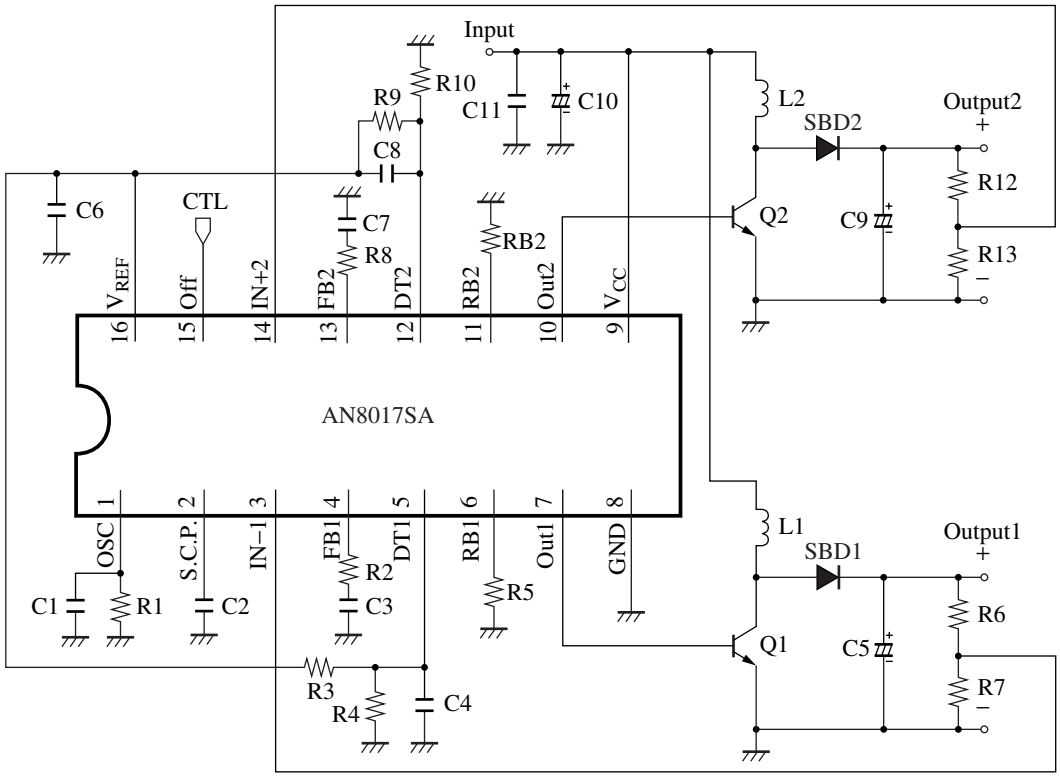


f — Gain

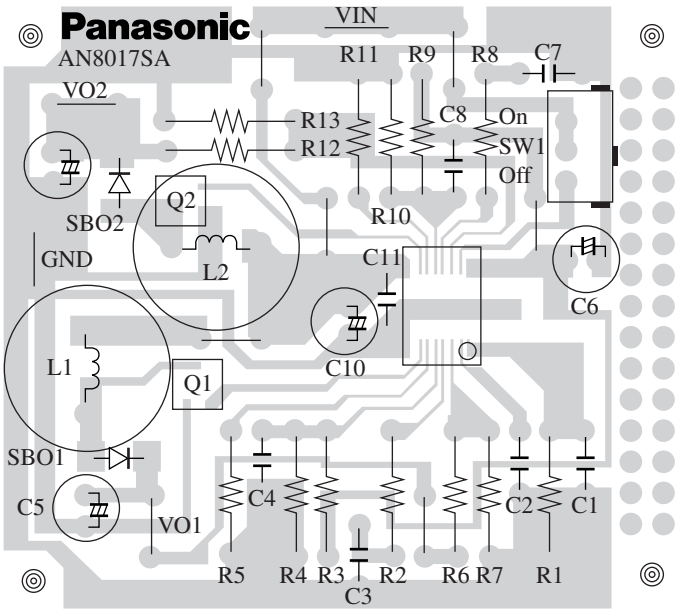


■ Application Circuit Examples

• Application circuit example 1

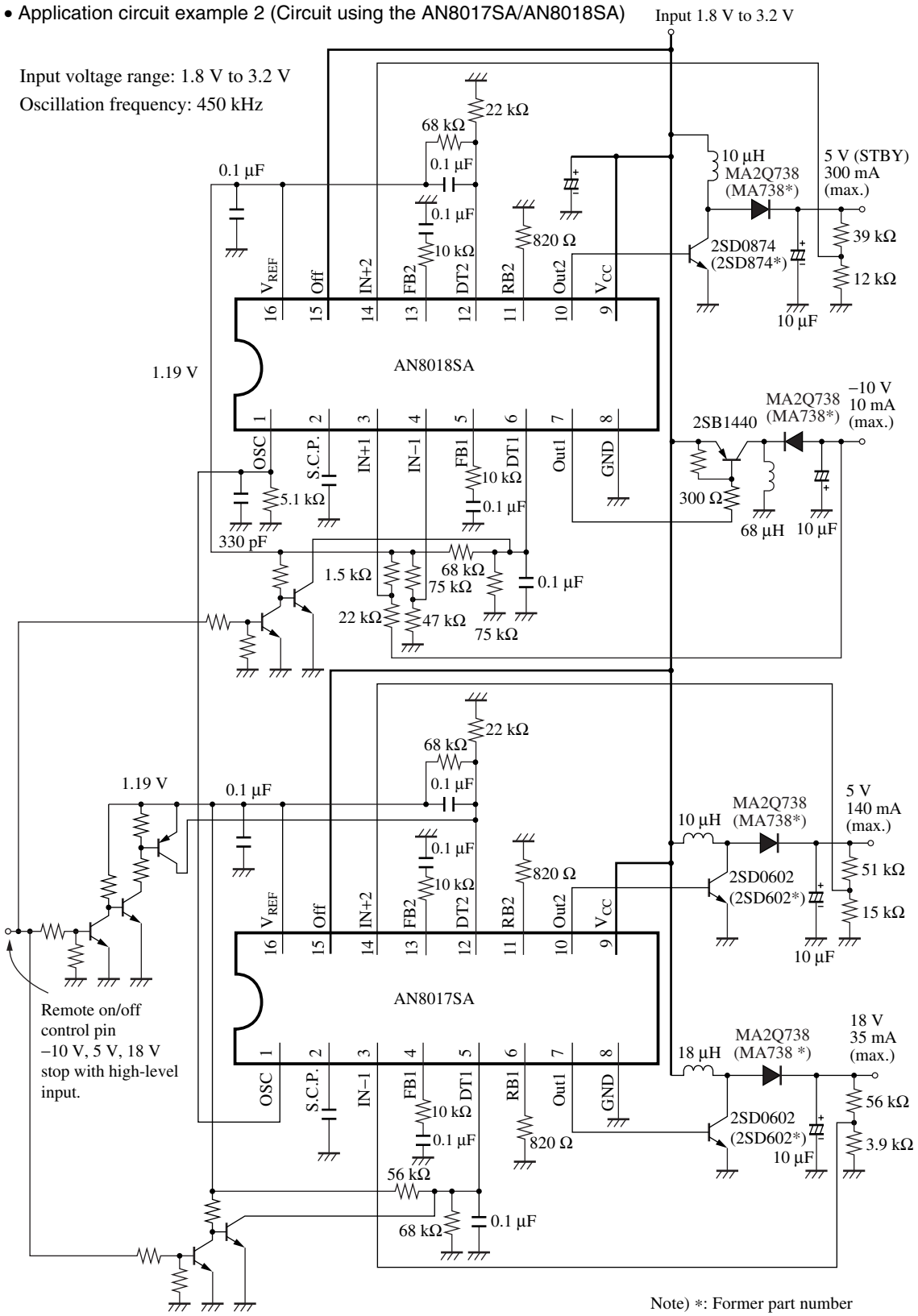


• Evaluation board



■ Application Circuit Examples (continued)

• Application circuit example 2 (Circuit using the AN8017SA/AN8018SA)



Note) ∗: Former part number

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